

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6072767

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	HYOSEOP LEE	04/22/2020
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<b>City:</b>	SEOUL	
<b>State/Country:</b>	KOREA, REPUBLIC OF	
<b>Postal Code:</b>	135-831	
<b>PROPERTY NUMBERS Total: 7</b>		
<b>Property Type</b>	<b>Number</b>	
Application Number:	14819705	
Application Number:	14819720	
Application Number:	14861050	
Application Number:	15168119	
Application Number:	15271331	
Application Number:	15857024	
Application Number:	15857284	
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<b>SIGNATURE:</b>	/John H. Choi/	

<b>DATE SIGNED:</b>	04/22/2020
<b>Total Attachments: 1</b> source=Lee Hyoseop Assignments#page1.tif	

### ASSIGNMENT

WHEREAS, the undersigned ("Assignor") is an inventor of the inventions claimed in U.S. Patent Application Nos. 14/819,705; 14,819,720 (U.S. Pat. No. 10,254,319); 14/861,050; 15/168,119 (U.S. Pat. No. 10,324,118); 15/271,331; 15/857,024; and 15/857,284 ("Patent Applications").

WHEREAS, Encored Technologies, Inc., a company organized under the laws of the Republic of Korea, having an address at KTS Building, Nonhyeon-dong 8F, 215 Bongeunsa-ro, Gangnam-gu, Seoul 135-831, Republic of Korea (hereinafter "Assignee"), is desirous of acquiring Assignor's right, title and interest in and to said inventions, said Patent Applications and any patents that may be granted thereon or therefrom.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, Assignor hereby sells, assigns and sets over to said Assignee the entire right, title and interest in and for the U.S. and all other countries in and to said inventions and the aforesaid applications, all original, divisional, continuation, continuation-in-part, substitute or reissue applications and patents (or equivalents thereof) applied for or granted therefor or therefrom in the U.S. and all other countries, together with all priority rights and rights to any damages for past, present and future infringement relating to any of the aforesaid applications, including the Patent Applications, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said application and/or applications resulting therefrom to said Assignee herein as assignee of the Assignor's entire interest therein; and the undersigned for him and his legal representatives, heirs and assigns does hereby agree and covenant, without further remuneration, to execute and deliver all divisional, continuation, continuation-in-part, reissue, reexamination and other applications for patent on said inventions and all assignments thereof to said Assignee or its assigns, to communicate to said Assignee or its legal representatives all facts known to undersigned respecting said inventions, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths and to do generally everything necessary to aid said Assignee, its successors, assigns and nominees in obtaining patent protection on said inventions in all countries, the expenses incident to said applications to be borne and paid by said Assignee.

Date: \_\_\_\_\_

By: \_\_\_\_\_

Hyoseop Lee